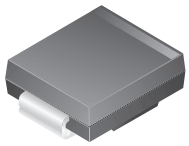
FAIRCHILD SEMICONDUCTOR™

ES3A - ES3D

Features

- For surface mount applications.
- Glass passivated junction.
- Low profile package.
- Easy pick and place.
- Built-in strain relief.
- Superfast recovery times for high efficiency.



SMC/DO-214AB
COLOR BAND DENOTES CATHODE

3.0 Ampere Superfast Rectifiers

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$I_{F(AV)}$	Average Rectified Current .375 " lead length @ T_A = 75°C	3.0	A
I_{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	100	A
P_D	Total Device Dissipation Derate above 25°C	2.66 21.28	W mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient**	47	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead**	12	°C/W
T_{stg}	Storage Temperature Range	-50 to +150	°C
T_J	Operating Junction Temperature	-50 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

**Device mounted on FR-4 PCB 0.013 mm.

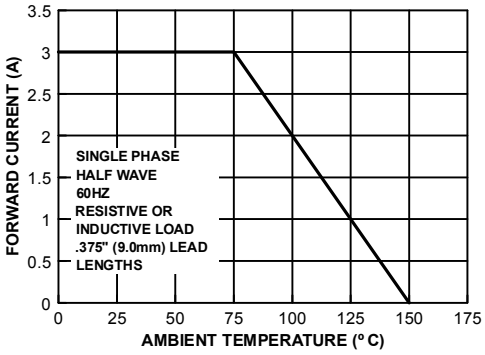
Electrical Characteristics

T_A = 25°C unless otherwise noted

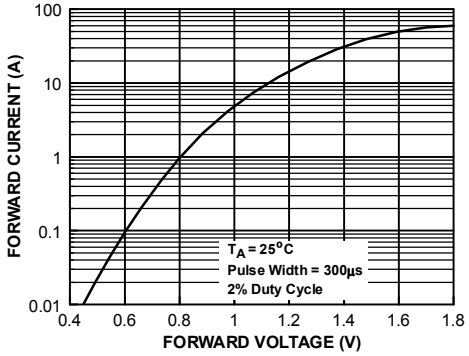
Symbol	Parameter	Device				Units
		3A	3B	3C	3D	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	150	200	V
V_{RMS}	Maximum RMS Voltage	35	70	105	140	V
V_R	DC Reverse Voltage (Rated V_R)	50	100	150	200	V
I_{RM}	Maximum Instantaneous Reverse Current @ rated V_R T_A = 25°C T_A = 100°C	10 500				µA µA
t_{rr}	Maximum Reverse Recovery Time I_F = 0.5 A, I_R = 1.0 A, I_{RR} = 0.25 A	20				ns
V_{FM}	Maximum Instantaneous Forward Voltage @ 3.0 A	0.90				V
C	Typical Junction Capacitance V_R = 4.0 V, f = 1.0 MHz	45				pF

Typical Characteristics

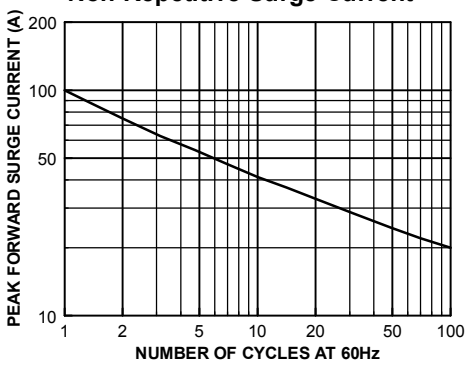
Forward Current Derating Curve



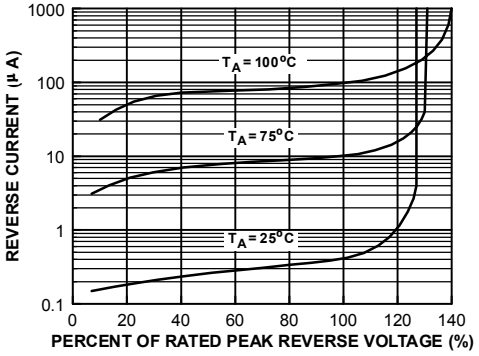
Forward Characteristics



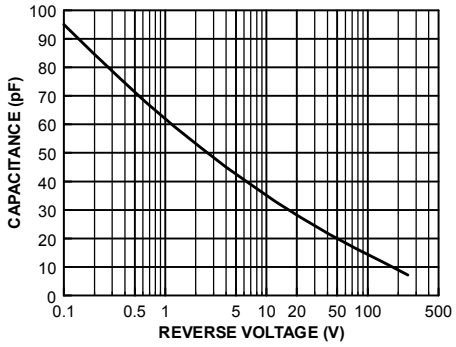
Non-Repetitive Surge Current

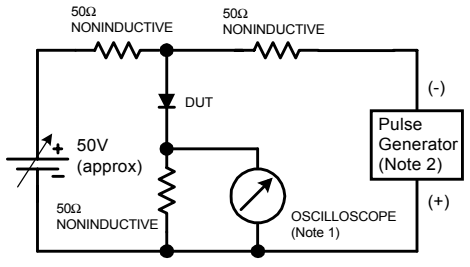


Reverse Characteristics

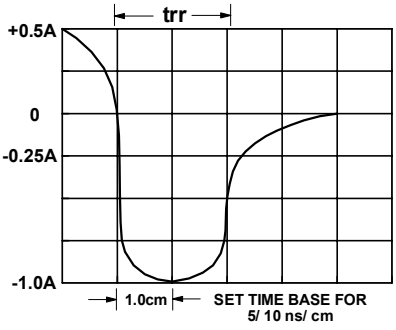


Junction Capacitance





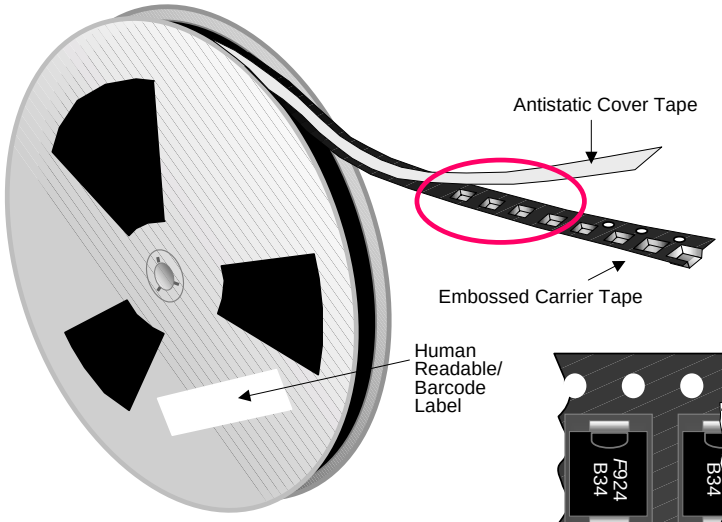
NOTES:
1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf.
2. Rise time = 10 ns max; Source impedance = 50 ohms.



Reverse Recovery Time Characterstic and Test Circuit Diagram

DO-214AB(SMC) Tape and Reel Data

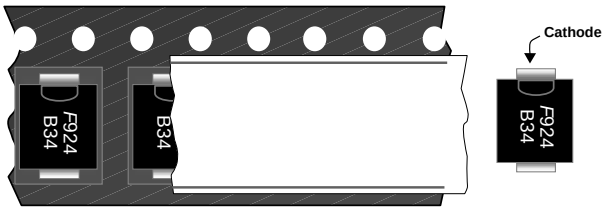
DO-214AB(SMC) Packaging
Configuration: Figure 1.0



Packaging Description:

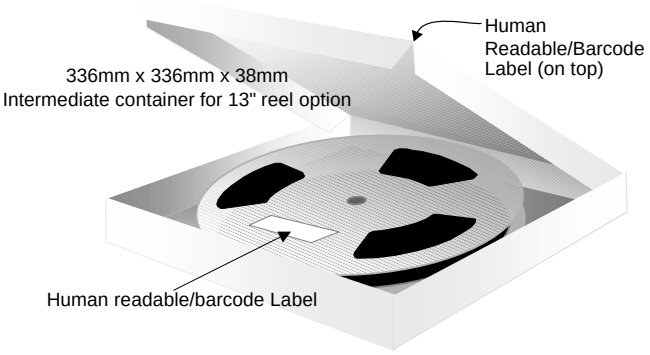
DO-214AB(SMC) parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. Alternate carrier tape is made of anti-static plastic. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 7,500 units per 13" or 330cm diameter reel. The reel comes in plastic or carton which is made of polystyrene plastic (anti-static coated) and thick white paper respectively. Further information is described in the Packaging Information table.

These full reels are individually labeled and placed inside a bleach box (illustrated in figure 1.0) made of recyclable carton paper with a Fairchild logo printing. One box contains two reels maximum. Certain number of these boxes are placed inside shipping box which comes in different sizes depending on the number of parts shipped.



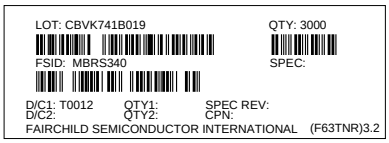
DO-214AB(SMC) unit orientation

DO-214AB(SMC) Packaging Information		
Packaging Option	Under package code **P5**	Under package code **MA**
Packaging type	TNR	TNR
Qty per Reel/Tube/Bag	3,000	3,000
Reel Size (inch diameter)	13	13
Box Dimension (mm)	336x336x38	336X336X38
Max qty per Box	6,000	6,000
Weight per unit (gm)	0.210	0.210
Weight per Reel (kg)	1.130	1.130
Note/Comments	Human readable label	Barcode label

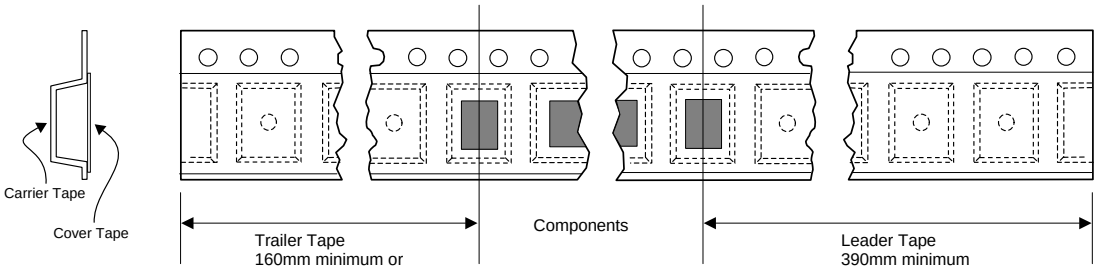


Human Readable Label sample

F63TNR Label sample

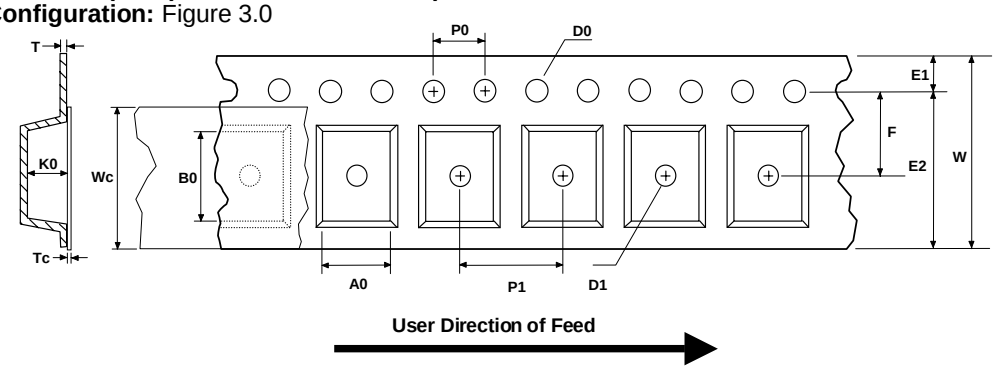


DO-214AB(SMC) Tape Leader and Trailer
Configuration: Figure 2.0



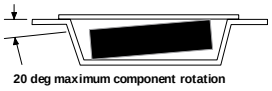
DO-214AB(SMC) Tape and Reel Data, continued

DO-214AB(SMC) Embossed Carrier Tape
Configuration: Figure 3.0

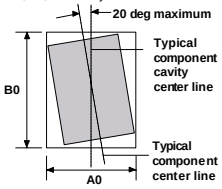


Dimensions are in millimeter														
Pkg type	**A0**	**B0**	**W**	**D0**	**D1**	**E1**	**E2**	**F**	**P1**	**P0**	**K0**	**T**	**Wc**	**Tc**
DO-214AB(SMC) (12mm)	6.00 +/-0.15	8.25 +/-0.20	16.0 +/-0.3	1.55 +/-0.05	1.125 +/-0.125	1.75 +/-0.10	10.25 min	7.5 +/-0.05	8.0 +/-0.1	4.0 +/-0.1	2.4 +/-0.30	0.40 +/-0.10	13.0 +/-0.3	0.06 +/-0.02

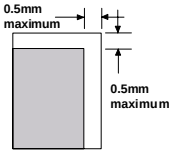
Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation

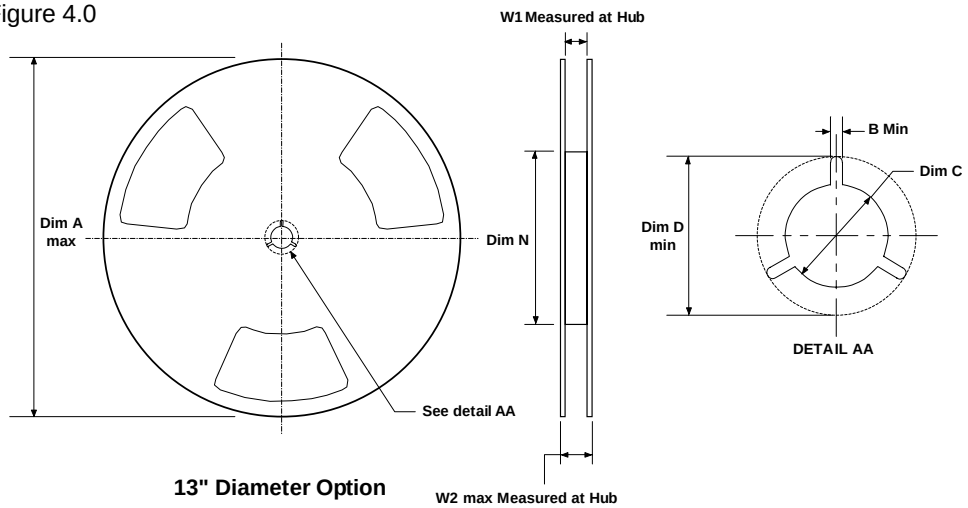


Sketch B (Top View)
Component Rotation



Sketch C (Top View)
Component lateral movement

DO-214AB(SMC) Reel Configuration:
Figure 4.0



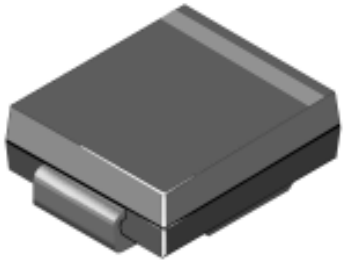
13" Diameter Option

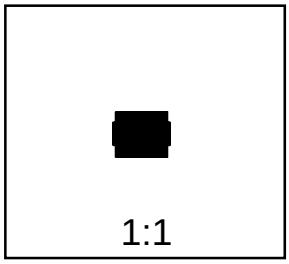
Dimensions are in inches and millimeters								
Tape Size	**Reel Option**	**Dim A**	**Dim B**	**Dim C**	**Dim D**	**Dim N**	**Dim W1**	**Dim W2**
12mm	13" Dia	13.0 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	1.97 50 min	0.646 +0.078/-0.000 16.4 +2/-0	0.724 18.4

DO-214AB(SMC) Package Dimensions

FAIRCHILD SEMICONDUCTOR™

DO-214AB(SMC) (FS PKG Code P7)

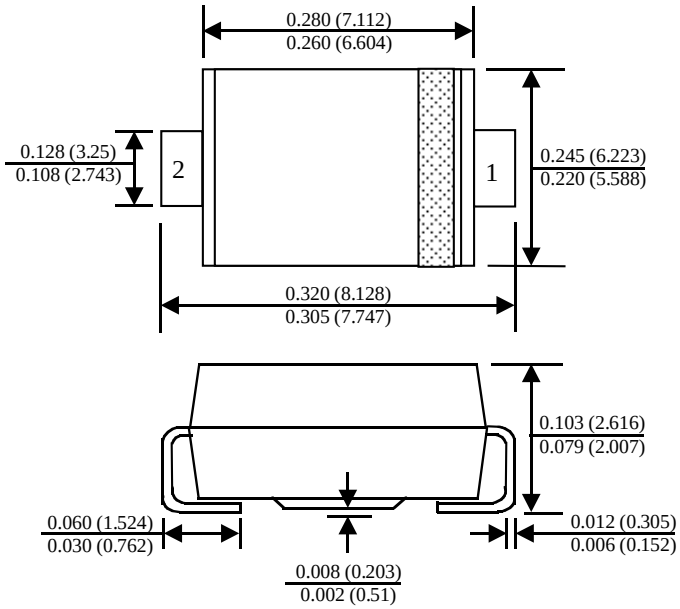


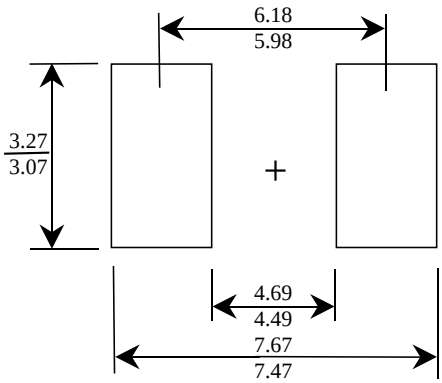


Scale 1:1 on letter size paper

Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.21





Minimum Recommended
Land Pattern

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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